



1N65-KW

Power MOSFET

1A, 650V N-CHANNEL POWER MOSFET

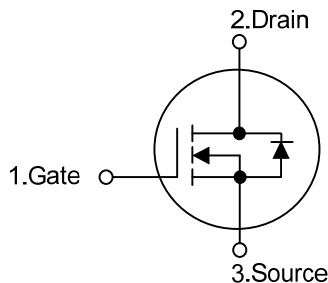
DESCRIPTION

The UTC **1N65-KW** is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} < 15\Omega$ @ $V_{GS}=10V$, $I_D=0.5A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL



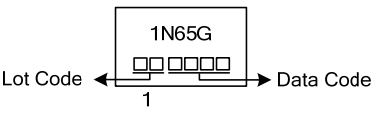
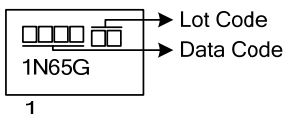
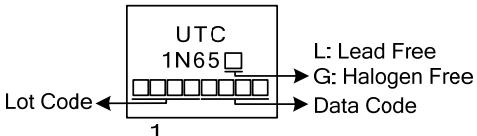
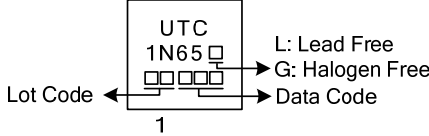
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
-	1N65G-AA3-R	SOT-223	G	D	S	Tape Reel
-	1N65G-AB3-R	SOT-89	G	D	S	Tape Reel
1N65L-TM3-T	1N65G-TM3-T	TO-251	G	D	S	Tube
1N65L-T92-B	1N65G-T92-B	TO-92	G	D	S	Tape Box
1N65L-T92-K	1N65G-T92-K	TO-92	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

1N65G-AA3-R	(1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel, B: Tape Box, K: Bulk (2) AA3: SOT-223, AB3: SOT-89, TM3: TO-251 T92: TO-92 (3) L: Lead Free, G: Halogen Free and Lead Free
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MARKING

<p>SOT-223</p> 	<p>SOT-89</p> 
<p>TO-251</p> 	<p>TO-92</p> 

■ **ABSOLUTE MAXIMUM RATINGS** ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current		I_D	1	A
Avalanche Energy	Single Pulsed (Note 2)	E_{AS}	23	mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	4.5	V/ns
Power Dissipation ($T_A=25^\circ\text{C}$)	SOT-89	P_D	0.69	W
	SOT-223		0.8	W
	TO-251		1.1	W
	TO-92		0.6	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Operating Temperature		T_{OPR}	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. $L = 46\text{mH}$, $I_{AS} = 1\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

3. $I_{SD} \leq 1.2\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-89	θ_{JA}	180	$^\circ\text{C}/\text{W}$
	SOT-223		150	$^\circ\text{C}/\text{W}$
	TO-251		110	$^\circ\text{C}/\text{W}$
	TO-92		180	$^\circ\text{C}/\text{W}$
Junction to Case	SOT-89	θ_{JC}	38	$^\circ\text{C}/\text{W}$
	SOT-223		14	$^\circ\text{C}/\text{W}$
	TO-251		4.53	$^\circ\text{C}/\text{W}$
	TO-92		88	$^\circ\text{C}/\text{W}$

■ **ELECTRICAL CHARACTERISTICS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified.)

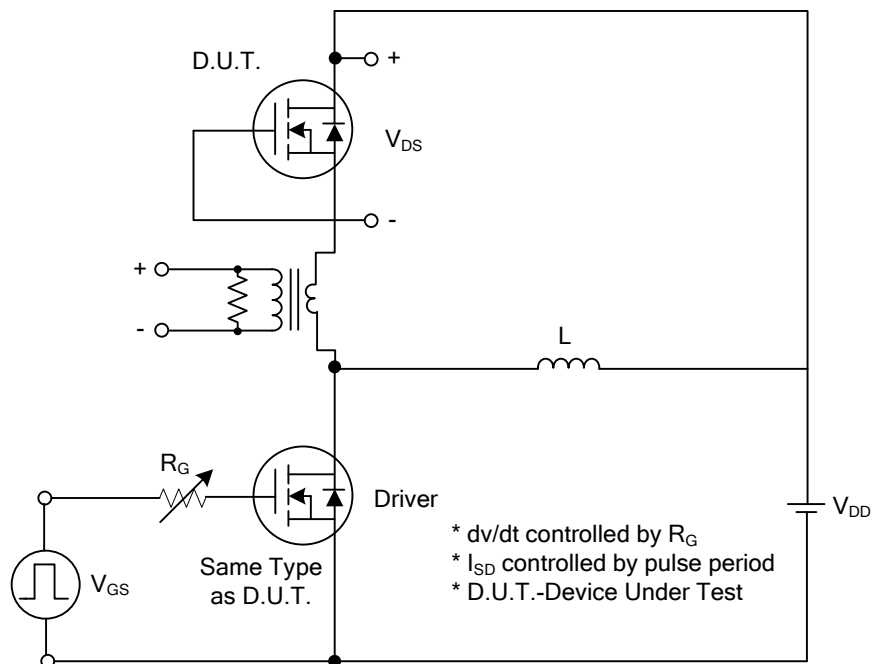
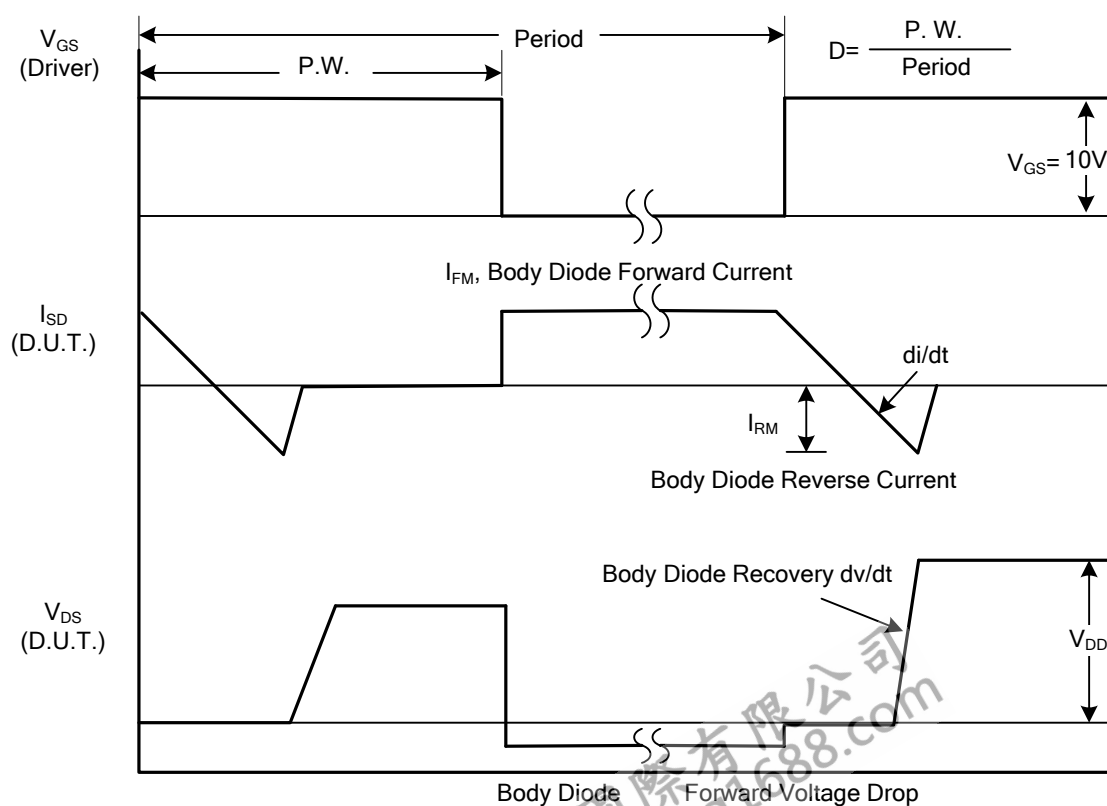
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
Breakdown Voltage Temperature Coefficient		ΔBV _{DSS} /ΔT _J	I _D =250μA		0.4		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.5A		12	15	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		150		pF
Output Capacitance		C _{OSS}			17.5		pF
Reverse Transfer Capacitance		C _{RSS}			4.6		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q _G	V _{DS} =50V, I _D =1.3A, R _G =3.3kΩ V _{GS} =10V, (Note 2,3)		8		nC
Gate-Source Charge		Q _{GS}			1.8		nC
Gate-Drain Charge		Q _{GD}			1.3		nC
Turn-On Delay Time		t _{D(ON)}	V _{DD} =30V, I _D =1A, R _G =25Ω, V _{GS} =10V (Note 2,3)		15		ns
Turn-On Rise Time		t _R			30		ns
Turn-Off Delay Time		t _{D(OFF)}			26		ns
Turn-Off Fall Time		t _F			35		ns
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} =0V, I _S =1A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current		I _S				1.0	A
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}				4.0	A

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

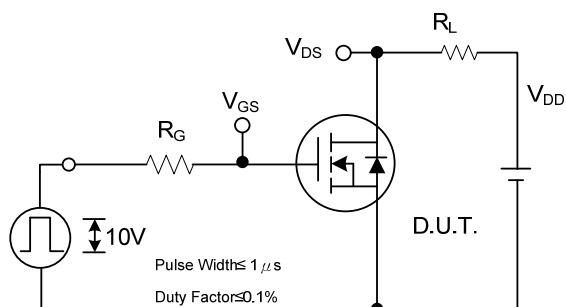
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

3. Essentially Independent of Operating Temperature

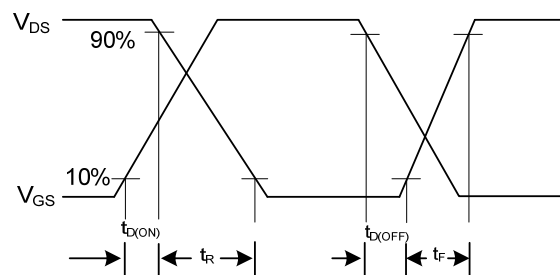
■ TEST CIRCUITS AND WAVEFORMS

Peak Diode Recovery dv/dt Test CircuitPeak Diode Recovery dv/dt Waveforms

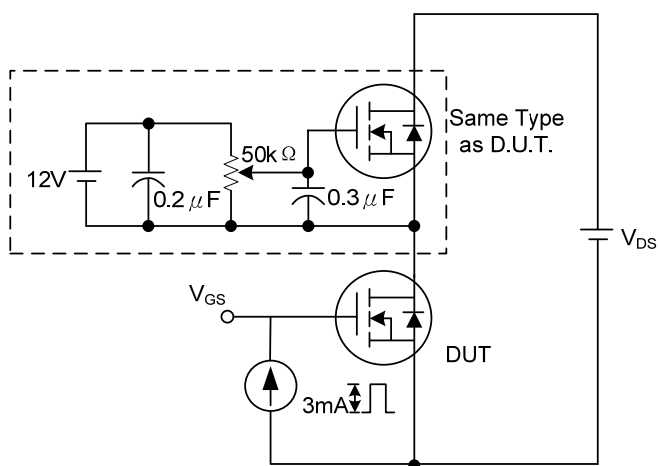
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



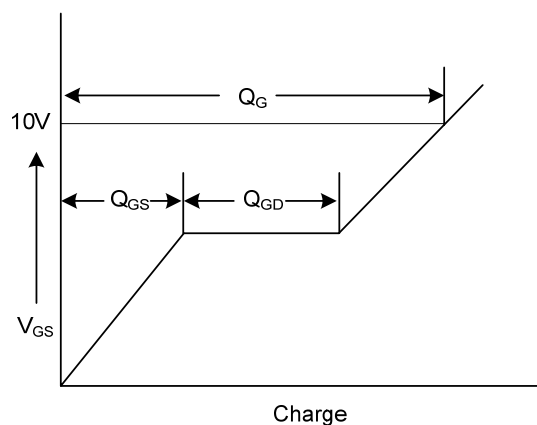
Switching Test Circuit



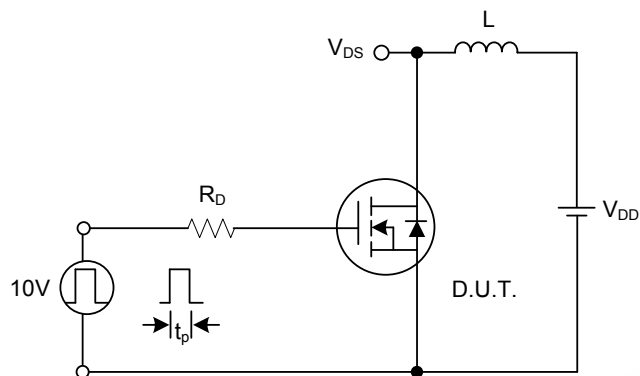
Switching Waveforms



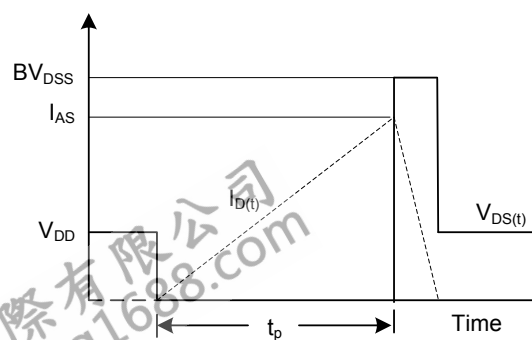
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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